Name,Value,Category,Description
Vout,12 V,System Information,Operational Output Voltage
IC Tolerance,5 mV,IC,IC Feedback Tolerance
Cin IRMS,2.52 A,Capacitor,Input capacitor RMS ripple current
Cin Pd,9.5 mW,Capacitor,Input capacitor power dissipation
Cout IRMS,420.76 mA,Capacitor,Output capacitor RMS ripple current
Cout Pd,118.03 µW,Capacitor,Output capacitor power dissipation
L Ipp,1.46 A,Inductor,Peak-to-peak inductor ripple current
L Pd,679.78 mW,Inductor,Inductor power dissipation
Ipp percentage,29.15%,Inductor,Inductor ripple current percentage (with respect to average inductor curre
Duty Cycle,51.33%,System Information,Duty cycle
Efficiency,91.6%,System Information,Steady state efficiency
Frequency,494.58 kHz,System Information,Switching frequency
IC Tj,136.57 °C,IC,IC junction temperature
IC Pd,4.84 W,IC,IC power dissipation
Pout,60 W,System Information,Total output power
Iin Avg,2.73 A,IC,Average input current
IC Ipk,5.73 A,IC,Peak switch current in IC
Mode,CCM,System Information,Conduction Mode
Vout p-p,12.05 mV,System Information,Peak-to-peak output ripple voltage
Vin p-p,476.44 mV,System Information,Peak-to-peak input voltage
Phase Marg,54.44 °,System Information,Bode Plot Phase Margin
Cross Freq,36.69 kHz,System Information,Bode plot crossover frequency
Low Freq Gain,49.29 dB,System Information,Gain at 1Hz
Gain Marg,-17.67 dB,System Information,Bode Plot Gain Margin
ICThetaJA Effective,22 °C/W,IC,Effective IC Junction-to-Ambient Thermal Resistance
Vout Ripple requirement used for Cout calculations,1.00%,System Information,Custom maximum output r
Overshoot Value,69.74 mV,System Information,Theoretical Vout Overshoot Value
Undershoot Value,152.29 mV,System Information,Theoretical Vout Undershoot Value
Vout transient requirement used for Cout calculations,3.00%,System Information,Custom Transient voltag
Iout transient step used for Cout calculations,2.5 A,System Information,Custom Transient current step req
Inductor ripple current requirement used for Inductor selection,30.00%,System Information,Custom Induc
Total Pd,5.54 W,Power,Total Power Dissipation
FootPrint,NA,System Information,Total Foot Print Area of BOM components
Vin,24 V,System Information,Vin operating point
Iout,5 A,System Information,Iout operating point
Cin Pd,9.5 mW,Power,Input capacitor power dissipation
Cout Pd,118.03 µW,Power,Output capacitor power dissipation
L Pd,679.78 mW,Power,Inductor power dissipation
IC Pd,4.84 W,Power,IC power dissipation
Vout Actual,11.99 V,System Information,Vout Actual calculated based on selected voltage divider resistors
Vout Tolerance,2.52%,System Information,Vout Tolerance based on IC Tolerance (no load) and voltage divi
Total BOM,NA,System Information,Total BOM Cost
BOM Count,13 ,System Information,Total Design BOM count

ent)

ripple requirement that was used for Cout selection(% of Vout).

ge change requirement that was used for Cout selection (% of Vout).
uirement that was used for Cout selection (A).
tor ripple current (% of average inductor current) requirement used for Inductor selection

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ider resistors if applicable